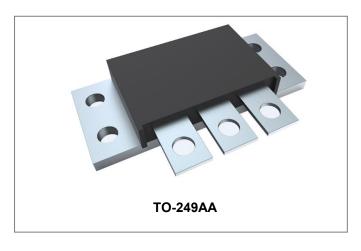






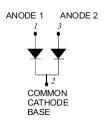
166CMQ200 SCHOTTKY RECTIFIER



Features

- 175°C T_J operation
- Isolated heatsink
- Low profile, high current package
- Center tap module
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Base plate: Nickel plated; Terminals: Nickel plated
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Schematic & Pin Configuration



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection

Maximum Ratings(limiting values, at 25 °C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	200	>
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @T _C =87°C, rectangular wave form	80(Per Leg) 160(Per Device)	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	960	Α

- China Germany Korea Singapore United States
 - http://www.smc-diodes.com sales@ smc-diodes.com •







Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(Peg Leg)*	V_{F1}	@ 80A, Pulse, T _J = 25 °C	0.92	1.10	V
	V_{F2}	@ 80A, Pulse, T _J = 125 °C	0.81	0.90	V
Reverse Current(Peg Leg)*	I _{R1}	@V _R = rated V _R , T _J = 25 °C	0.1	1500	uA
	I _{R2}	@V _R = rated V _R ,T _J = 125 °C	0.07	21	mA
Junction Capacitance(Peg Leg)	Ст	$@V_R = 5V, T_C = 25 \text{ °C}$ $f_{SIG} = 1MHz$	740	900	pF
Voltage Rate of Change	dv/dt	-	-	10,000	V/μs

 $^{^*}$ Pulse width < 300 μ s, duty cycle < 2%

Thermal-Mechanical Specifications:

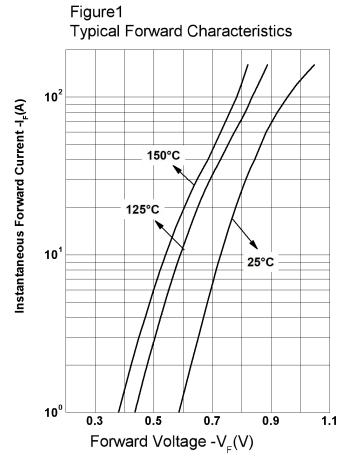
Characteristics	Symbol	Condition	Specification	Units	
Junction Temperature	TJ	-	-55 to +175	°C	
Storage Temperature	T _{stg}	-	-55 to +175	°C	
Typical Thermal Resistance Junction to Case (Per Leg)	R ₀ JC	DC operation	1.0	°C/W	
Typical Thermal Resistance Junction to Case (Per Package)	R ₀ JC	DC operation	0.50	°C/W	
Typical Thermal Resistance, case to Heat Sink	$R_{ heta cs}$	Mounting surface, smooth and greased	0.10	°C/W	
Mounting Torque	T _M	-	40(min) 58(max)	Kg-cm	
Approximate Weight	wt	-	61	g	
Case Style	TO-249(9 pin)				

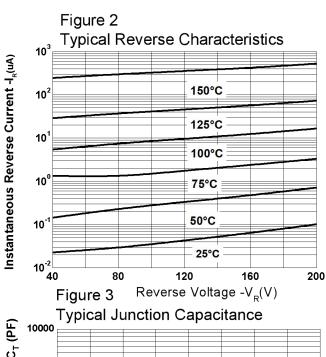


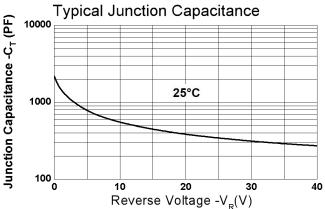




Ratings and Characteristics Curves







Ordering Information

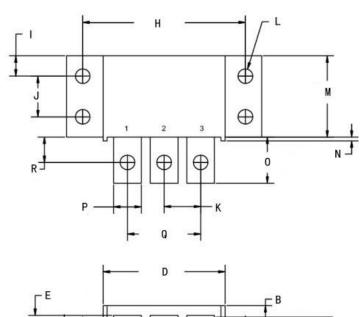
Device	Package	Shipping	
166CMQ200	TO-249AA(Pb-Free)	24pcs/ box	







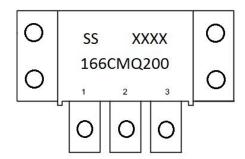
Mechanical Dimensions TO-249AA (Inches/Millimeters)



	-	- D	-	-		
- E		13.0046	890 W		—FB	
1	1			丗		
ا الله			G -	-		FΔ

SYMBOL	Millimeters		Inches		
STIMBUL	Min.	Max.	Min.	Max.	
Α	60.38	61.58	2.377	2.424	
В	8.38	10.16	0.330	0.400	
С	2.77	3.57	0.109	0.141	
D	37.00	38.20	1.457	1.504	
Е	0.62	1.32	0.024	0.052	
F	6.	35	0.250		
G	1.27		0.050		
Н	50.80		2.000		
I	6.35		0.250		
J	12.70		0.500		
K	11.43		0.450		
L	4.35	5.05	0.171	0.199	
М	24.90	25.90	0.980	1.020	
N	0.64	1.26	0.025	0.050	
0	11.80	13.51	0.465	0.532	
Р	8.64		0.340		
Q	22.86		0.900		
R	7.93		0.312		

Marking Diagram



Where XXXX is YYWW

1st row SS YYWW 2nd row 166CMQ200 3rd row 1 2 3 (pin) = ŠS SS ΥY = Year WW = Week

Cautions: Molding resin

Epoxy resin UL:94V-0







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